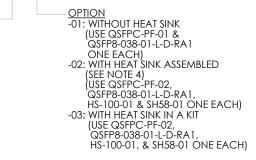
REVISION F

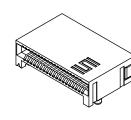


DESIGNED & DIMENSIONED IN MILLIMETERS[INCHES]

QSFPK-PF-XX

PRESS FIT





QSFP8-038-01-L-D-RA1

TOLERANCES ARE:

X.X: ±0.3 [.01] X.XX: ±0.13 [.005]

INSULATOR: LCP

X.XXX: ±0.051 [.0020]

DECIMALS

MATERIAL:

QSFPC-PF-01

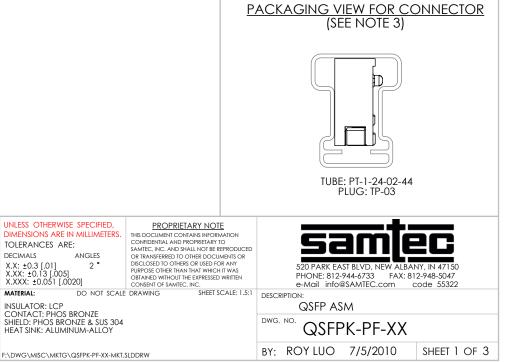
(QSFPK-PF-01 SHOWN)

TABLE 1		
STYLE	PART NUMBER	QUANTITY
QSFPK-PF-01	QSFPC-PF-01	1.000
	QSFP8-038-01-L-D-RA1	1.000
	PT-1-24-02-44	0.033
	TP-03	0.066
	PT-RPB1001	0.110
	TP-04	0.220
QSFPK-PF-02	QSFPC-PF-02	1.000
	QSFP8-038-01-L-D-RA1	1.000
	PT-1-24-02-44	0.033
	TP-03	0.066
	PT-RPB1001	0.110
	TP-04	0.220
QSFPK-PF-03	QSFPC-PF-03	1.000
	QSFP8-038-01-L-D-RA1	1.000
	HS-100-01	1.000
	SH58-01	1.000
	PT-1-24-02-44	0.033
	TP-03	0.232
	PT-RPB1001	0.110
	TP-04	0.220
	PT-1-24-14-29	0.083
	PT-1-24-01-34	0.045
	TP-07	0.090

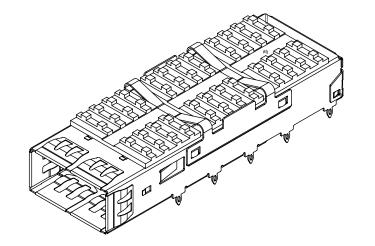
NOTES:

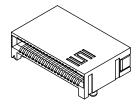
C REPRESENTS A CRITICAL DIMENSION.
MINIMUM PUSHOUT FORCE: 1.11N[0.25 LB].
OPTIONS -01 & -02 MUST BE PACKAGE IN TRAYS, FOR OPTION -03 CAGE MUST BE PACKAGED IN TRAYS, HEAT SINK AND SHIELD MUST BE PACKAGED IN TUBES
HEAT SINK MUST BE REMOVED PRIOR TO TERMINATION TO PRINTED CIRCUIT BOARD.
SEE OFEC DE APPLICATION TO PRIONAL TERMINATION TO PRINTED CIRCUIT BOARD.

5. SEE QSFPC-PF APPLICATION FOR ADDITIONAL TERMINATION INSTRUCTIONS.





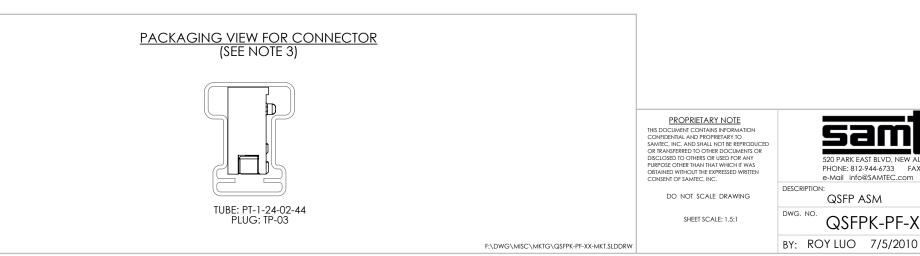




QSFP8-038-01-L-D-RA1

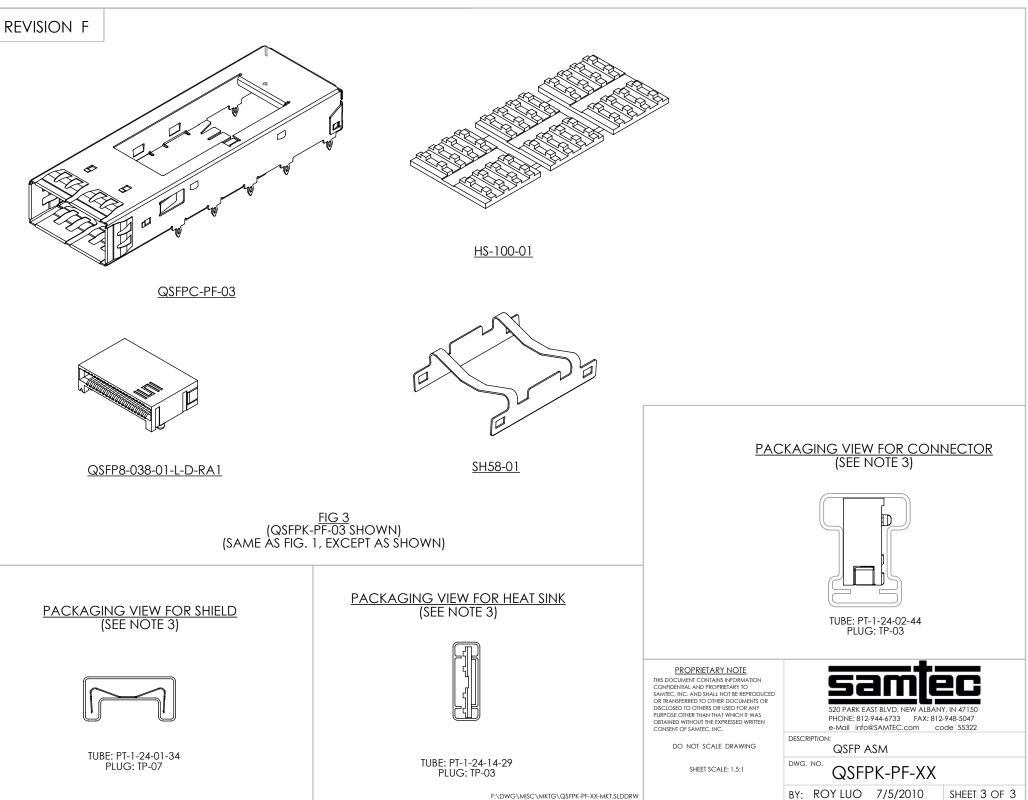
QSFPC-PF-02

<u>FIG 2</u> (QSFPK-PF-02 SHOWN) (SAME AS FIG. 1, EXCEPT AS SHOWN)





SHEET 2 OF 3



F:\DWG\MISC\MKTG\QSFPK-PF-XX-MKT.SLDDRW